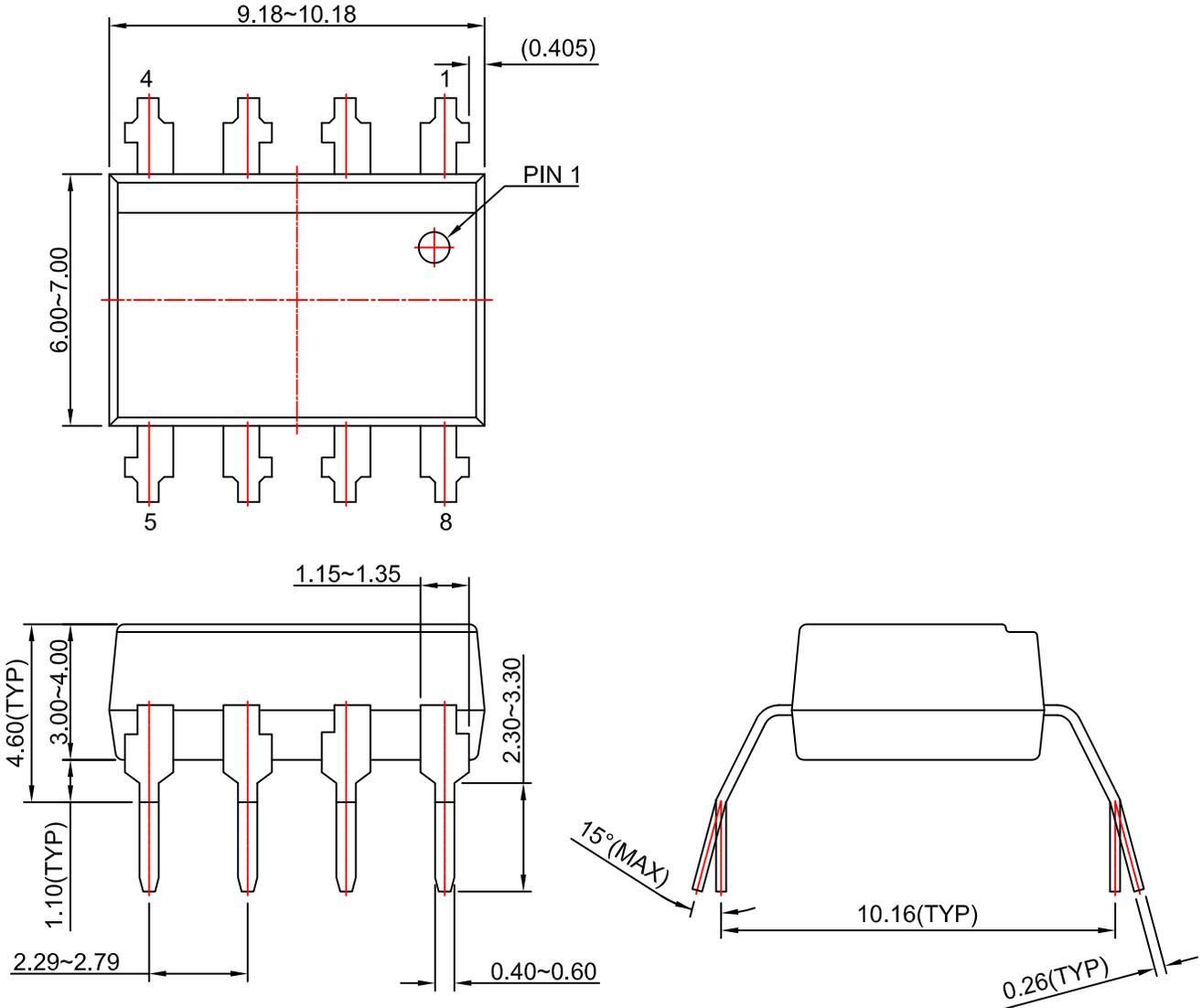


# MECHANICAL CASE OUTLINE

## PACKAGE DIMENSIONS

PDIP8 9.68x6.5, 2.54P  
CASE 646CJ  
ISSUE 0

DATE 31 JUL 2016



**NOTES:**

- A) NO STANDARD APPLIES TO THIS PACKAGE.
- B) ALL DIMENSIONS ARE IN MILLIMETERS.
- C) DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSION

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